I²C Micro-stepping Motor Driver

INTRODUCTION

The AMIS

APPLICATIONS

The AMIS 30624/NCV70624 is ideally suited for small positioning applications. Target markets include: automotive (headlamp alignment, HVAC, idle control, cruise control), industrial equipment (lighting, fluid control, labeling, process control, XYZ tables, robots) and building

automation (HVAC, surveillance, satellite dish, renewable energy systems). Suitable applications typically have multiple axes or require mechatronic solutions with the driver chip mounted directly on the motor.

Table 1. ORDERING INFORMATION

Part No.	Peak Current	End Market/Version	Package*	Shipping [†]	
AMIS30624C6244G	800 mA		SOIC-20 (Pb-Free)	Tube/Tray	
AMIS30624C6244RG	MIS30624C6244RG 800 mA		SOIC-20 (Pb-Free)	Tape & Reel	
AMIS30624C6245G	800 mA	High Voltage Version	NQFP-32 (7 x 7 mm) (Pb-Free)	Tube/Tray	
AMIS30624C6245RG	800 mA		NQFP-32 (7 x 7 mm) (Pb-Free)	Tape & Reel	
NCV70624DW010G	800 mA	Automotive	SOIC-20 (Pb-Free)	Tube/Tray	
NCV70624DW010R2G	800 mA	Version	SOIC-20 (Pb-Free)	Tape & Reel	

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

QUICK REFERENCE DATA

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter Min Max Unit

V_{BB}, V_{HW}

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PACKAGE THERMAL RESISTANCE

The AMIS 30624/NCV70624 is available in SOIC 20 or optimized NQFP 32 packages. For cooling optimizations, the NQFP has an exposed thermal pad which has to be soldered to the PCB ground plane. The ground plane needs thermal vias to conduct the head to the bottom layer. Figures 3 and 4 give examples for good power distribution solutions.

For precise thermal cooling calculations the major thermal resistances of the devices are given. The thermal media to which the power of the devices has to be given are:

Static environmental air (via the case)

PCB board copper area (via the device pins and

exposed pad)

The thermal resistances are presented in Table 5: DC Parameters.

The major thermal resistances of the device are the Rth from the junction to the ambient (Rthja) and the overall Rth from the junction to the leads (Rthjp).

The NQFP device is designed to provide superior thermal performance. Using an exposed die pad on the bottom surface of the package is mainly contributing to this performance. In order to take full advantage of the exposed pad, it is most important that the PCB has features to conduct heat away from the package. A thermal grounded pad with thermal vias can achieve this.

In the table below, one can find the values for the Rthja and Rthjp, simulated according to the JESD 51 norm:

Package	Rth Junction–to–Leads and Exposed Pad – Rthjp	Rth Junction-to-Leads Rthjp	Rth Junction–to–Ambient Rthja (1S0P)	Rth Junction–to–Ambient Rthja (2S2P)
SOIC-20		19	62	39
NQFP-32	0.95			

DC PARAMETERS

The DC parameters are guaranteed overtemperature and V_{BB} in the operating range, unless otherwise specified. Convention: currents flowing into the circuit are defined as positive.

Table 5. DC PARAMETERS

Symbol	Pin(s)	Parameter	Test Conditions	Min	Тур	Max	Unit
MOTORDRI	/ER						
I _{MSmax,Peak}		Max current through motor coil in normal operation	V _{BB} = 14 V		800		mA
I _{MSmax,RMS}		Max rms current through coil in normal operation	V _{BB} = 14 V		570		mA
I _{MSabs}	MOTVD	Absolute error on coil current (Note 5)	V _{BB} = 14 V	-10		10	%
I _{MSrel}	MOTXP MOTXN MOTYP	Matching of X & Y coil currents	V _{BB} = 14 V	-7	0	7	%
R _{DS(on)}	ΜΟΤΥΝ	On resistance for each	V_{BB} = 12 V, T _j = 50 C		0.50	1	Ω
		(Note 6)	$V_{BB} = 8 V, T_j = 50 C$		0.55	1	Ω
			$V_{BB} = 12 \text{ V}, \text{ T}_{j} = 150 \text{ C}$		0.70	1	Ω
			$V_{BB} = 8 V, T_j = 150 C$		0.85	1	Ω
I _{MSI}		Pulldown current	HiZ mode, V _{BB}	-	-	-	-

Table 5. DC PARAMETERS

Symbol	Pin(s)	Parameter	Test Conditions	Min	Тур	Max	Unit
SUPPLY AN	ID VOLTA	GE REGULATOR					
V _{DD}		Regulated internal supply (Note 13)	8 V < V _{BB} < 29 V	4.75	5	5.50	V
V _{ddReset}	V _{DD}	Digital supply reset level @ power down (Note 14)				4.5	V
I _{ddLim}		Current limitation	Pin shorted to ground V _{BB} = 14 V			45	mA
SWITCH IN	PUT AND I	HARDWIRE ADDRESS INPUT		•	•		
Rt_OFF		Switch OPEN resistance (Note 15)		10			kΩ
Rt_ON	SWI HW	Switch ON resistance (Note 15)	Switch to GND or V_{BB}			2	kΩ

	(11010-10)					
V _{bb_sw}	V _{BB} range for guaranteed operation of SWI and HW		6		29	V
l _{lim_sw}	Current limitation	Short to GND or V _{bat} V _{BB} = 29 V	20	30	45	mA

TEST PIN

V _{ihigh}		Input level high	V _{BB} = 14 V	0.7 * V _{dd}		V
V _{ilow}	TST	Input level low	V _{BB} = 14 V		0.3 * V _{dd}	V
HW _{hyst}		Hysteresis	V _{BB} = 14 V	0.075 * V _{dd}		

Table 6. AC PARAMETERS

Symbol	Pin(s)	Parameter	Тур	Max	Unit		
SWITCH INF	PUT AND	HARDWIRE ADDRESS INPUT					
T _{sw}	S/M/I	Scan pulse period (Note 21)	V _{BB} = 14 V		1024		μs
T _{sw_on}	HW	Scan pulse duration (Note 21)	V _{BB} = 14 V		128		μs

MOTORDRIVER

F _{pwm}		PWM frequency (Note 21)	PWMfreq = 0 (Note 22)	20.6	22.8	25.0	kHz
			PWMfreq = 1 (Note 22)	41.2	45.6	50.0	kHz
F _{jit_depth}	MOTYY	PWM jitter modulation depth	PWMJen = 1 (Note 22)		10		%
T _{brise}	NOT XX						

Typical Application





GND

POSITIONING PARAMETERS

Stepping Modes

One of four possible stepping modes can be programmed:

Half stepping

1/4 micro stepping

1/8 micro stepping

1/16 micro stepping

Maximum Velocity

For each stepping mode, the maximum velocity Vmax can be programmed to 16 possible values given in the table below.

The accuracy of Vmax is derived from the internal oscillator. Under special circumstances it is possible to change the Vmax

Minimum Velocity

Once the maximum velocity is chosen, 16 possible values can be programmed for the minimum velocity Vmin. The table below provides the obtainable values in full step/s. The accuracy of Vmin is derived from the internal oscillator.

				Vmax (Full-step/s)														
Vmin	Index	Vmax	Α		В						C)			D			
Hex	Dec	Factor	99	136	167	197	213	228	243	273	303	334	364	395	456	546	729	973
0	0	1	99	136	167	197	213	228	243	273	303	334	364	395	456	546	729	973
1	1	1/32	3	4	5	6	6	7	7	8	8	10	10	11	13	15	19	27
2	2	2/32	6	8	10	11	12	13	14	15	17	19	21	23	27	31	42	57
3	3	3/32	9	12	15	18	19	21	22	25	27	31	32	36	42	50	65	88
4	4	4/32	12	16	20	24	26	28	30	32	36	40	44	48	55	65	88	118
5	5	5/32	15	21	26	31	32	35	37	42	46	51	55	61	71	84	111	149
6	6	6/32	18	25	31	36	39	42	45	50	55	61	67	72	84	99	134	179
7	7	7/32	21	30	36	43	46	50	52	59	65	72	78	86	99	118	156	210
8	8	8/32	24	33	41	49	52	56	60	67	74	82	90	97	113	134	179	240
9	9	9/32	28	38	47	55	59	64	68	76	84	93	101	111	128	153	202	271
А	10	10/32	31	42	51	61	66	71	75	84	93	103	113	122	141	168	225	301
В	11	11/32	34	47	57	68	72	78	83	93	103	114	124	135	156	187	248	332
С	12	12/32	37	51	62	73	79	85	91	101	113	124	135	147	170	202	271	362
D	13	13/32	40	55	68	80	86	93	98	111	122	135	147	160	185	221	294	393
E	14	14/32	43	59	72	86	93	99	106	118	132	145	158	172	198	237	317	423
F	15	15/32	46	64	78	93	99	107	113	128	141	156	170	185	214	256	340	454

Table 8. OBTAINABLE VALUES IN FULL-STEP/s FOR THE MINIMUM VELOCITY

Position Ranges

A position is coded by using the binary two's complement format. According to the positioning commands used and to the chosen stepping mode, the position range will be as shown in the following table.

Table 11. POSITION RANGE

Command

Two DAC's to set the correct current ratio through X and Y.

Battery voltage monitoring is also performed by this block, which provides the required information to the control logic part. The same applies for detection and reporting of an electrical problem that could occur on the coils or the charge pump.

Control Logic (Position Controller and Main Control)

The control logic block stores the information provided by the I^2C interface (in a RAM or an OTP memory) and digitally controls the positioning of the stepper motor in terms of speed and acceleration, by feeding the right signals to the motordriver state machine.

It will take into account the successive positioning commands to properly initiate or stop the stepper motor in order to reach the set point in a minimum time.

It also receives feedback from the motordriver part in order to manage possible problems and decide on internal actions and reporting to the I^2C interface.

Motion Detection

Motion detection is based on the back emf generated internally in the running motor. When the motor is blocked,

e.g. when it hits the end position, the velocity, and as a result also the generated back

Table 13. POSITION RELATED PARAMETERS

Parameter	Reference				
Pmax – Pmin	See Positioning				
Zero Speed Hold Current	See Ihold				
Maximum Current	See Irun				
Acceleration and Deceleration	See Acceleration and Deceleration				
Vmin	See Minimum Velocity				
Vmax	See Maximum Velocity				

Different positioning examples are shown in the table below.

Table 14. POSITIONING EXAMPLES

Short motion.	Velocity time
New positioning command in same direction, shorter or longer, while a motion is running at maximum velocity.	Velocity
New positioning command in same dir- ection while in deceleration phase (Note 23)	Velocity
Note: there is no wait time between the deceleration phase and the new acceleration phase.	time
New positioning command in reverse direction while motion is running at maximum velocity.	Velocity
New positioning command in reverse direction while in deceleration phase.	Velocity
New velocity programming while motion is running.	Velocity

23. Reaching the end position is always guaranteed, however velocity rounding errors might occur after consecutive accelerations during a deceleration phase. The velocity rounding error will be removed at Vmin (e.g. at end of acceleration or when AccShape=1).

Dual Positioning

A <u>SetDualPosition</u> command allows the user to perform a positioning using two different velocities. The first motion is done with the specified Vmin and Vmax velocities in the <u>SetDualPosition</u> command, with the acceleration (deceleration) parameter already in RAM, to a position Pos1[15:0] also specified in <u>SetDualPosition</u>.

Then a second relative motion to a physical position Pos1[15:0] + Pos2[15:0] is done at the specified Vmin velocity in the <u>SetDualPosition</u> command (no



Figure 9. Motion Direction is Function of Difference between ActPos and TagPos

Hardwired Address HW

In the drawing below, a simplified schematic diagram is shown of the HW comparator circuit.

The HW pin is sensed via 2 switches. The DriveHS and DriveLS control lines are alternatively closing the top and bottom switch connecting HW pin with a current to resistor converter. Closing S_{TOP} (DriveHS = 1) will sense a current to GND. In that case the top I \rightarrow R converter output is low, via the closed passing switch S_{PASS_T} this signal is fed to the "R" comparator which output HW_Cmp is high. Closing bottom switch S_{BOT} (DriveLS = 1) will sense a current to V_{BAT} . The corresponding I \rightarrow R converter output is low and via S_{PASS_B} fed to the comparator. The output HW_Cmp will be high.



1 2 3

1 = R2GND

Previous State	DriveLS	DriveHS	HW_Cmp	New State	Condition	Drawing
Float	1	0	0	Float	R2GND or OPEN	1 or 3
Float	1	0	1	High	R2VBAT	2
Float	0	1	0	Float	R2VBAT or OPEN	2 or 3
Float	0	1	1	Low	R2GND	1
Low	1	0	0	Low	R2GND or OPEN	1 or 3
Low	1	0	1	High	R2VBAT	2
Low	0	1	0	Float	R2VBAT or OPEN	2 or 3
Low	0	1	1	Low	R2GND	1
High	1	0	0	Float	R2GND or OPEN	1 or 3
High	1	0	1	High	R2VBAT	2
High	0	1	0	High	R2VBAT or OPEN	2 or 3
High	0	1	1	Low	R2GND	1

Table 15. STATE DIAGRAM OF THE HW COMPARATOR

The logic is controlling the correct sequence in closing the switches and in interpreting the $32 \,\mu s$ debounced HW_Cmp output accordingly. The output of this small state machine is corresponding to:

As illustrated in the table above (Table 15), the state is depending on the previous state, the condition of the 2 switch controls (DriveLS and DriveHS) and the output of

High or address = 1

Low or address = 0

Floating









Thermal Shutdown Mode

When thermal shutdown occurs, the circuit performs a <SoftStop> command and goes to motor shutdown mode (see Figure 14: State Diagram Temperature Management).

Temperature Management

The AMIS 30624/NCV70624 monitors temperature by means of two thresholds and one shutdown level, as

illustrated in the state diagram and illustration of Figure 14: State Diagram Temperature Management below. The only condition to reset flags <TW> and <TSD> (respectively thermal warning and thermal shutdown) is to be at a temperature lower than Ttw and to get the occurrence of a GetFullStatus1 I^2C frame.



GetFullStatus1

OTP Register

OTP Memory Structure

The table below shows how the parameters to be stored in the OTP memory are located.

Address	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0x00	OSC3	OSC2	OSC1	OSC0	IREF3	IREF2	IREF1	IREF0
0x01	0	TSD2	TSD1	TSD0	BG3	BG2	BG1	BG0
0x02	AbsThr3	AbsThr2	AbsThr1	AbsThr0	PA3	PA2	PA1	PA0
0x03	Irun3	Irun2	Irun1	Irun0	lhold3	Ihold2	Ihold1	Ihold0
0x04	Vmax3	Vmax2	Vmax1	Vmax0	Vmin3	Vmin2	Vmin1	Vmin0
0x05	SecPos10	SecPos9	SecPos8	Shaft	Acc3	Acc2	Acc1	Acc0
0x06	SecPos7	SecPos6	SecPos5	SecPos4	SecPos3	SecPos2		
0x07	DelThr3	DelThr2	DelThr1	DelThr0	StepMode1	StepMode0	LOCKBT	LOCKBG

Table 17. OTP MEMORY STRUCTURE

Parameters stored at address 0x00 and 0x01 and bit <LOCKBT> are already programmed in the OTP memory at circuit delivery. They correspond to the calibration of the circuit and are just documented here as an indication.

Each OTP bit is at '0' when not zapped. Zapping a bit will set it to '1'. Thus only bits having to be at '1' must be zapped. Zapping of a bit already at '1' is disabled. Each OTP byte will be programmed separately (see command <u>SetOTPparam</u>). Once OTP programming is completed, bit <LOCKBG> can be zapped to disable future zapping, otherwise any OTP bit at '0' could still be zapped by using a <u>SetOTPparam</u> command.

Table 18. OTP OVERWRITE PROTECTION

Lock Bit	Protected Bytes
LOCKBT (factory zapped before delivery)	0x00 to 0x01
LOCKBG	0x00 to 0x07

The command used to load the application parameters via the I^2C bus in the RAM prior to an OTP Memory programming is $\underline{\texttt{SetMotorParam}}$

Del Thr [3: 0] Relative threshold used for the motion detection

Index	DelThr				DelThr Level (V) (*)		
0	0	0 0		0	Disable		
1	0	0	0	1	0.25		
2	0	0	1	0	0.50		
3	0	0	1	1	0.75		
4	0	1	0	0	1.00		
5	0	1	0	1	1.25		
6	0	1	1	0	1.50		
7	0	1	1	1	1.75		
8	1	0	0	0	2.00		
9	1	0	0	1	2.25		
A	1	0	1	0	2.50		
В	1	0	1	1	2.75		
С	1	1	0	0	3.00		
D	1	1	0	1	3.25		
E	1 1 1 0		0	3.50			
F	1	1	1	1	3.75		

(*) Not tested in production. Values are approximations.

I r un[3: 0] Current amplitude value to be fed to each coil of the stepper motor. The table below provides the 16 possible values for <IRUN>.

Index	Irun				Run Current (mA)		
0	0	0	0	0	59		
1	0	0	0	1	71		
2	0	0	1	0	84		
3	0	0	1	1	100		
4	0	1	0	0	119		
5	0	1	0	1	141		
6	0	1	1	0	168		
7	0	1	1	1	200		
8	1	0	0	0	238		
9	1	0	0	1	283		
A	1	0	1	0	336		
В	1	0	1	1	400		
С	1	1	0	0	476		
D	1	1	0	1	566		
E	1	1	1	0	673		
F	1	1	1	1	800		

I hol d[3: 0] Hold current for each coil of the stepper motor. The table below provides the 16 possible values for <IHOLD>.

Index		lhc	old		Hold Current (mA)
0	0	0	0	0	59
1	0	0	0	1	71
2	0	0	1	0	84
3	0	0	1	1	100
4	0	1	0	0	119
5	0	1	0	1	141
6	0	1	1	0	168
7	0	1	1	1	200
8	1	0	0	0	238
9	1	0	0	1	283
A	1	0	1	0	336
В	1	0	1	1	400
С	1	1	0	0	476
D	1	1	0	1	566
E	1		1	0	673
F	1	1	1	1	0

Note: When the motor is stopped, the current is reduced from <IRUN> to <IHOLD>. In the case of 0 mA hold

Note: The Secure Position is coded on 11 bits only,

Table 19. RAM REGISTERS

Register	Mnemonic	Length (bit)	Related Commands	Comment	Reset State
Actual position	ActPos	16	<u>GetFullStatus2</u> <u>GotoSecurePos</u> <u>ResetPosition</u>	16-bit signed	
Last programmed Position	Pos/TagPos	16/11	<u>GetFullStatus2</u> <u>GotoSecurePos</u> <u>ResetPosition</u> <u>SetPosition</u>	16–bit signed or 11–bit signed for half stepping (see <u>Positioning</u>)	
Acceleration shape	AccShape	1	<u>GetFullStatus1</u> <u>SetMotorParam</u> ResetToDefault	'0' normal acceleration from Vmin to Vmax '1'	

Table 20. FLAGS TABLE

Flag	Mnemonic	Length (bit)	Related Commands	Comment	Reset State
------	----------	-----------------	------------------	---------	----------------

Priority Encoder

The table below describes the simplified state management performed by the main control block.

Table 21. PRIORITY ENCODER

State →	Standby	Stopped	GotoPos	DualPosition	SoftStop	HardStop	ShutDown	HardUnder	ShutUnder
Command ↓		Motor Stopped, Ihold in Coils	Motor Motion Ongoing	No Influence on RAM and Tag- Pos	Motor				

31. <EIFlag> = <CPFail> or <UV2> or <EIDef> or <VDDreset>

32. After power-on-reset, the <Standby> state is entered.

- 33. A DualPosition sequence runs with a separate set of RAM registers. The parameters that are not specified in a DualPosition command are loaded with the values stored in RAM at the moment the DualPosition sequence starts. <AccShape> is forced to '1' during second motion. <AccShape> at '0' will be taken into account after the DualPosition sequence. A <u>GetFullStatus1</u> command will return the default parameters for <Vmax> and <Vmin> stored in RAM.
- 34. Shutdown state can be left only when <TSD> and <HS> flags are reset.
- 35. Flags can be reset only after the master could read them via a <u>GetFullStatus1</u> command, and provided the physical conditions allow for it (normal temperature, correct battery voltage and no electrical or charge pump defect).
- 36. A <u>SetMotorParam</u> command sent while a motion is ongoing (state <GotoPos>) should not attempt to modify <Acc> and <Vmin> values. This can be done during a DualPosition sequence since this motion uses its own parameters, the new parameters will be taken into account at the next <u>SetPosition</u> command.
- 37. <SecEn> = '1' when register <SecPos> is loaded with a value different from the most negative value (i.e. different from 0x400 = "100 0000").
- 38. Stop> flag allows distinguishing whether state <stopped> was entered after HardStop/SoftStop or not. <stop> is set to '1' when leaving
 state <HardStop> or <SoftStop> and is reset during first clock edge occurring in state <stopped>.
- 39. While in state <Stopped>, if <ActPos> <TagPos> there is a transition to state <GotoPos>. This transition has the lowest priority, meaning that <Stop>, <TSD>, etceteras are first evaluated for possible transitions.
- 40. If <StepLoss> is active, then <u>SetPosition</u> and <u>GotoSecurePosition</u> commands are not ignored. <StepLoss> can only be cleared by a <u>GetFullStatus1</u> command.





Motor Starting Phase

This can be illustrated in the following sequence given as an application example. The master can check whether there is a problem or not and decide which application strategy to adopt.

Tj Tsd or V _{BB} UV2 (>15s) or <eldef> = '1' or <cpfail> = '1' (>15s)</cpfail></eldef>	SetPosition fame	GetFullStatus1 f ame	GetFullStatus1 f ame 	
 The circuit is driven in motor shutdown mode The application is <u>not</u> aware of this The application is <u>not</u> aware of this 	 The position set-point is updated by the I²C Master 	 The application is aware of a problem 	 Possible confirmation of the problem 	
	 Motor shutdown mode no motion The application is still unaware 	 Reset <tw> or <tsd> or <uv2> or <steploss> or <eldef> or <cpfail> by the application</cpfail></eldef></steploss></uv2></tsd></tw> Possible new detection of over temperature or low voltage or electrical problem Circuit sets <tw> or <tsd> or <uv2> or <steploss> or <eldef> or <cpfail> again at '1'</cpfail></eldef></steploss></uv2></tsd></tw> 		

Important: While in shutdown mode, since there is no hold current in the coils, the mechanical load can cause a step loss, which indeed cannot be flagged by the AMIS 30624/NCV70624.

Note: The <u>Priority Encoder</u> is describing the management of states and commands.

Warning: The application should limit the number of consecutive <u>GetFullStatus1</u> commands to try to get the AMIS 30624/NCV70624 out of shutdown mode when this proves to be unsuccessful, e.g. there is a permanent defect. The reliability of the circuit could be altered since <u>GetFullStatus1</u> attempts to disable the protection of the H bridges.

Motion Detection

Motion detection is based on the back emf generated internally in the running motor. When the motor is blocked, e.g. when it hits the end stop, the velocity and as a result also the generated back emf, is disturbed. The AMIS 30624/NCV70624 senses the back emf, calculates a moving average and compares the value with two independent threshold levels: Absolute threshold (<u>AbsThr[3:0]</u>) and Delta threshold (<DelThr[3:0]>). Instructions for correct use of these two levels in combination with three additional parameters (<MinSamples>, <FS2StallEn> and <DC100StEn>) are available in a dedicated Application Note "Robust Motion Control with AMIS

Table 26. TRUTH TABLE

Condition	<delstalllo></delstalllo>	<delstallhi></delstallhi>	<absstall></absstall>	<stall></stall>
Vbemf < Average – DelThr	1	0	0	1
Vbemf > Average + DelThr	0	1	0	1
Vbemf < AbsThr	0	0	1	1

By design, the motion will only be detected when the

FS2StallEn

If <AbsThr> or <DelThr> <> 0 (i.e. motion detection

I²C BUS DESCRIPTION

General Description

AMIS 30624/NCV70624 uses a simple bi directional 2 wire bus for efficient inter ic control. This bus is called the Inter IC or I^2C bus.

Features include:

Only two bus lines are required; a serial data line (SDA) and a serial clock line (SCK).

Each device connected to the bus is software addressable by a unique address and simple master/slave relationships exists at all times; master can operate as master transmitter or as master receiver.

Serial, 8 bit oriented, bi directional data transfers can be made up to 400 kb/s.

On chip filtering rejects spikes on the bus data line to preserve data integrity.

Table 30. DEFINITION OF I²C–BUS TERMINOLOGY

No need to design bus interfaces because I^2C bus interface is already integrated on chip.

IC's can be added to or removed from a system without affecting any other circuits on the bus.

Concept

The I²C bus consists of two wires, serial data (SDA) and serial clock (SCK), carrying information between the devices connected on the bus. Each device connected to the bus is recognized by a unique address and operates as either a transmitter or receiver, depending on the function of the device. AMIS 30624/NCV70624 can both receive and transmit data. In addition to transmitters and receivers, devices can also be considered as masters or slaves when performing data transfers. AMIS 30624/NCV70624 is a slave device. See Table 31.

Term	Description				
Transmitter	The device which sends data on the bus				
Receiver	The device which receives data from the bus				
Master	he device which initiates a transfer, generates clock signals and terminates a transfer				
Slave	The devices addressed by a master				
Synchronization	Procedure to synchronizer the clock signals of two or more devices				



Figure 21. Example of an I²C-bus Configuration Using One Microcontroller and Four Slaves

Figure 21 highlights the master slave and receiver transmitter relationships to be found on the I^2C bus. It should be noted that these relationships are not permanent but only depend on the direction of data transfer at that time. The transfer of data would proceed as follows:

1. Suppose the microcontroller wants to send

information to motordriver_1:

- Microcontroller (master) addresses motordriver_1 (slave) Microcontroller (master transmitter) sends data to motordriver_1 (slave receiver) Microcontroller terminates the transfer
- 2. If the microcontroller wants to receive information from motordriver_2:

Microcontroller (master) addresses

motordriver_2 (slave)

Microcontroller (master receiver) receives data from motordriver 2 (slave transmitter)

Microcontroller terminates the transfer

Even in this case the master generates the timing and terminates the transfer.

Generation of the signals on the I^2C bus is always the responsibility of the master device. It generates its own clock signal when transferring data on the bus. Bus clock signals from a master can only be altered when they are stretched by a slow slave device holding down the clock line.

Transferring Data

Byte Format

Every byte put on the SDA line must be 8 bits long. The number of bytes that can be transmitted per transfer to AMIS 30624/NCV70624 is restricted to eight. Each byte has to be followed by an acknowledge bit. Data is transferred with the most significant bit (MSB) first (See Figure 25). If a slave can't receive or transmit another complete byte of data, it can hold the clock line SCK LOW to force the master into a wait state. Data transfer then continues when the slave is ready for another byte of data and releases clock line SCK.



Clock Generation

The master generates the clock on the SCK line to transfer messages on the I^2C bus. Data is only valid during the HIGH period of the clock.

Data Formats with 7-bit Addresses

Data transfers follow the format shown in Figure 27. After the START condition (S), a slave address is sent. This

address is 7 bit long followed by an eighth bit which is a data



Figure 30. Master Reading Data from AMIS-30624/NCV70624: Second Transmission is Reading Data

Notes:

- 1. Each byte is followed by an acknowledgment bit as indicated by the A or \overline{A} in the sequence.
- 2. I²C-bus compatible devices must reset their bus logic on receipt of a START condition such that they all anticipate the sending of a slave address, even if these START conditions are not positioned according to the proper format.
- 3. A START condition immediately followed by a STOP condition (void message) is an illegal format.

7-bit Addressing

The addressing procedure for the I^2C bus is such that the first byte after the START condition usually determines which slave will be selected by the master. The exception is the general call address which can call all devices. When this address is used all devices should respond with an acknowledge. The second byte of the general call address then defines the action to be taken.

Definition of Bits in the First Byte

The first seven bits of the first byte make up the slave address. The eighth bit is the least significant bit (LSB). It determines the direction of the message. If the LSB is a "zero" it means that the master will write information to a selected slave. A "one" in this position means that the master will read information from the slave. When an address is sent, each device in a system compares the first seven bits after the START condition with its address. If they match, the device considers itself addressed by the master as a slave receiver or slave transmitter, depending on the R/\overline{W} bit.



Figure 31. First Byte after START Procedure

AMIS 30624/NCV70624 is provided with a physical address in order to discriminate this circuit from other circuits on the I²C bus. This address is coded on seven bits (two bits being internally hardwired to '1'), yielding the theoretical possibility of 32 different circuits on the same bus. It is a combination of four OTP memory bits (<u>OTP Memory Structure OPEN</u>) and of the externally hardwired address bits (pin HW). HW must either be connected to ground or to V_{bat}. When HW is not connected and is left floating, correct functionality of the positioner is not guaranteed. The motor will be driven to the programmed secure position (See Hardwired Address – OPEN).



Figure 32. First Byte after START Procedure

General Call Address

The AMIS 30624/NCV70624 supports also a "general call" address "000 0000", which can address all devices. When this address is used all devices should respond with an acknowledge. The second byte of the general call address then defines the action to be taken.

I²C APPLICATION COMMANDS

Introduction

Communications between the AMIS 30624/NCV70624 and a 2 wire serial bus interface master takes place via a large set of commands.

Reading commands are used to:

Get actual status information, e.g. error flags Get actual position of the stepper motor Verify the right programming and configuration of the AMIS 30624/NCV70624.

Commands Table

Writing commands are used to: Program the OTP memory Configure the positioner with motion parameters (max/min speed, acceleration, stepping mode, etc.) Provide target positions to the Stepper motor The I²C bus master will have to use commands to manage the different application tasks the AMIS 30624/NCV70624 can feature. The commands summary is given in Table 31.

Table 31. I²C COMMANDS WITH CORRESPONDING ROM POINTER

		Command Byte		
Command Mnemonic	Function	Binary	Hexadecimal	
GetFullStatus1	Returns complete status of the chip	"1000 0001"	0x81	
GetFullStatus2	Returns actual, target and secure position	"1111 1100"	0xFC	
GetOTPParam	Returns OTP parameter	"1000 0010"	0x82	
GotoSecurePosition	Drives motor to secure position	"1000 0100"	0x84	
HardStop	Immediate full stop	"1000 0101"	0x85	
ResetPosition	Sets actual position to zero			

Application Commands

GetFullStatus1

This command is provided to the circuit by the master to get a complete status of the circuit and of the stepper motor. Refer to Tables 19 and 20 to see the meaning of the parameters sent back to the I^2C master.

Note: A GetFullStatus1 command will attempt to reset

GetFullStatus2

This command is provided to the circuit by the master to

SetDualPosition

This command is provided to the circuit by the $I^2 C$ master

SetMotorParam

This command is provided to the circuit by the I^2C master to set the values for the stepper motor parameters (listed below) in RAM. Refer to Table 19 to see the meaning of the parameters sent by the I^2C master.

Important: If a SetMotorParam occurs while a motion is ongoing, it will modify at once the motion parameters (see

SetMotorParam

Table 45. SetMotorParam COMMAND FRAME

<u>Position Controller</u> corresponds to the following I^2C command frame:). Therefore the application should not change parameters other than Vmax while a motion is running, otherwise correct positioning cannot be guaranteed.

		Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Address	1	1	OTP3	OTP2	OTP1	OTP0	HW	0
1	Command	1	0	0	0	1	0	0	1
2	Data 1	1	1	1	1	1	1	1	1
3	Data 2	1	1	1	1	1	1	1	1
4	Data 3	Irun[3:0]				Ihold[3:0]			
5	Data 4	Vmax[3:0]				Vmin[3:0]			
6	Data 5	SecPos[10:8] Shaft				Acc	[3:0]		

SetPosition

This command is provided to the circuit by the I²C master to drive the motor to a given absolute position. See <u>Positioning (see Priority Encoder)</u> for more details. The priority encoder table acknowledges the cases where a SetPosition command will be ignored.

SetPosition corresponds to the following I²C command frame:

Table 47. SetPosition COMMAND FRAME

		Structure							
Byte	Content	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	Address	1	1	OTP3	OTP2	OTP1	OTP0	HW	0
1	Command	1	0	0	0	1	0	1	1
2	Data 1	1	1	1	1	1	1	1	1
3	Data 2	1	1	1	1	1	1	1	1
4	Data 3	Pos[15:8]							
5	Data 4	Pos[7:0]							

Where:

Pos [15:0] Signed 16 bit position set point for motor.

SoftStop

This command will be internally triggered when the chip temperature rises above the thermal shutdown threshold (see



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